

N-Channel Power MOSFET

100V, 15A, 90mΩ

FEATURES

- 100% avalanche tested
- Low gate charge for fast switching
- Pb-free plating
- RoHS compliant
- Halogen-free mold compound

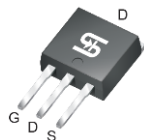
APPLICATION

- Networking
- Load Switching
- LED Lighting Control
- AC-DC Secondary Rectification

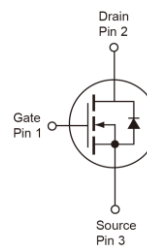
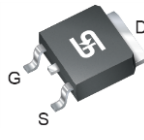
KEY PERFORMANCE PARAMETERS		
PARAMETER	VALUE	UNIT
V_{DS}	100	V
$R_{DS(on)}$ (max)	$V_{GS} = 10V$	90
	$V_{GS} = 4.5V$	100
Q_g	9.3	nC



TO-251S (IPAK SL)



TO-252 (DPAK)



Notes: Moisture sensitivity level: level 3. Per J-STD-020

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^(Note 1)	I_D	$T_C = 25^\circ\text{C}$	15
		$T_C = 100^\circ\text{C}$	9.5
Pulsed Drain Current ^(Note 2)	I_{DM}	60	A
Total Power Dissipation @ $T_C = 25^\circ\text{C}$	P_{DTOT}	50	W
Single Pulsed Avalanche Energy ^(Note 3)	E_{AS}	18	mJ
Single Pulsed Avalanche Current ^(Note 3)	I_{AS}	6	A
Operating Junction and Storage Temperature Range	T_J, T_{STG}	- 55 to +150	$^\circ\text{C}$

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction to Case Thermal Resistance	$R_{\theta JC}$	2.5	$^\circ\text{C/W}$
Junction to Ambient Thermal Resistance	$R_{\theta JA}$	62	$^\circ\text{C/W}$

Notes: $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case thermal reference is defined at the solder mounting surface of the drain pins. $R_{\theta JA}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design. $R_{\theta JA}$ shown below for single device operation on FR-4 PCB in still air.

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static (Note 4)						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV_{DSS}	100	--	--	V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	$V_{GS(TH)}$	1.2	1.6	2.5	V
Gate Body Leakage	$V_{GS} = \pm 20V, V_{DS} = 0V$	I_{GSS}	--	--	± 100	nA
Zero Gate Voltage Drain Current	$V_{DS} = 100V, V_{GS} = 0V$	I_{DSS}	--	--	1	μA
Drain-Source On-State Resistance	$V_{GS} = 10V, I_D = 5A$	$R_{DS(on)}$	--	72	90	m Ω
	$V_{GS} = 4.5V, I_D = 3A$		--	75	100	
Dynamic (Note 5)						
Total Gate Charge	$V_{DS} = 48V, I_D = 5A,$ $V_{GS} = 10V$	Q_g	--	9.3	--	nC
Gate-Source Charge		Q_{gs}	--	2.1	--	
Gate-Drain Charge		Q_{gd}	--	1.8	--	
Input Capacitance	$V_{DS} = 50V, V_{GS} = 0V,$ $f = 1.0\text{MHz}$	C_{iss}	--	1480	--	pF
Output Capacitance		C_{oss}	--	480	--	
Reverse Transfer Capacitance		C_{rss}	--	35	--	
Gate Resistance	$F = 1\text{MHz}, \text{open drain}$	R_g	--	1.3	--	Ω
Switching (Note 6)						
Turn-On Delay Time	$V_{DD} = 30V,$ $R_{GEN} = 3.3\Omega,$ $I_D = 1A, V_{GS} = 10V,$	$t_{d(on)}$	--	2.9	--	ns
Turn-On Rise Time		t_r	--	9.5	--	
Turn-Off Delay Time		$t_{d(off)}$	--	18.4	--	
Turn-Off Fall Time		t_f	--	5.3	--	
Source-Drain Diode (Note 4)						
Forward On Voltage	$I_S = 3.3A, V_{GS} = 0V$	V_{SD}	--	--	1	V
Continuous Drain-Source Diode	$V_G = V_D = 0V, \text{Force Current}$	I_S	--	--	15	A
Pulse Drain-Source Diode		I_{SM}	--	--	60	A

Notes:

1. Current limited by package
2. Pulse width limited by the maximum junction temperature
3. $L = 0.1\text{mH}, I_{AS} = 6A, V_{DD} = 50V, R_G = 25\Omega, \text{Starting } T_J = 25^\circ\text{C}$
4. Pulse test: $PW \leq 300\mu s, \text{duty cycle} \leq 2\%$
5. For DESIGN AID ONLY, not subject to production testing.
6. Switching time is essentially independent of operating temperature.

ORDERING INFORMATION (EXAMPLE)

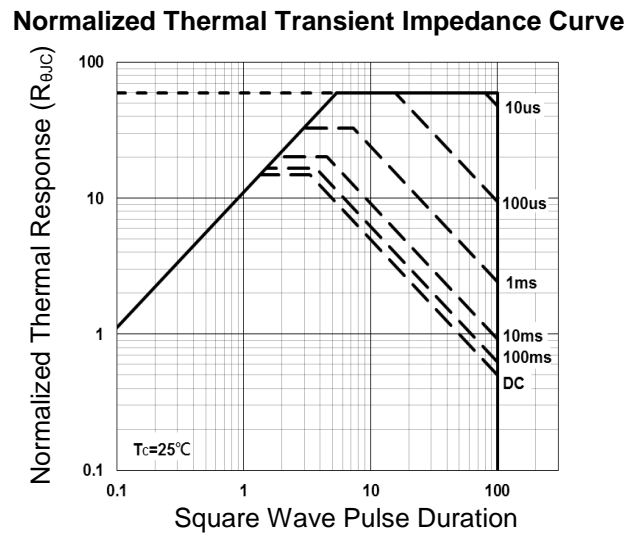
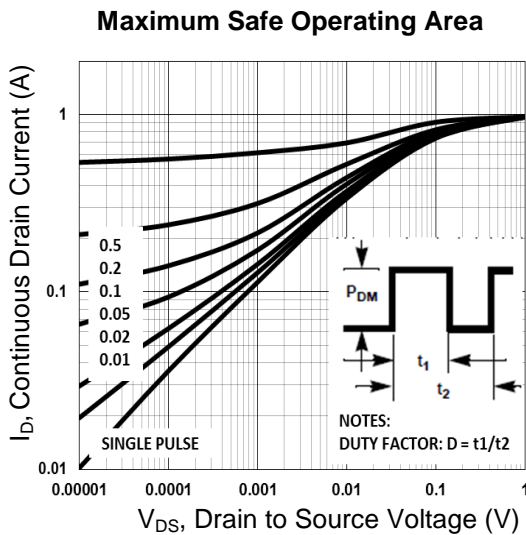
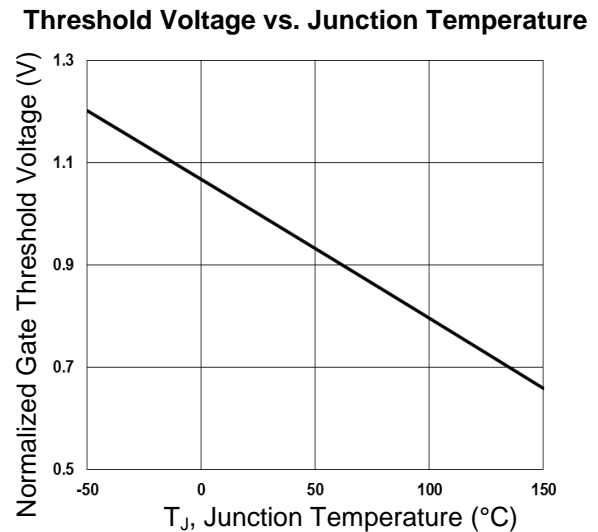
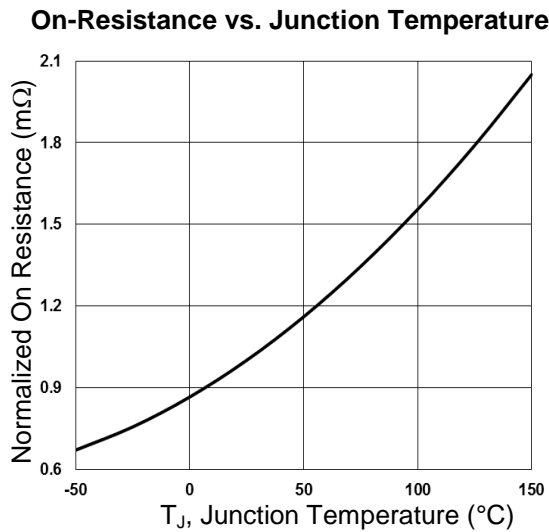
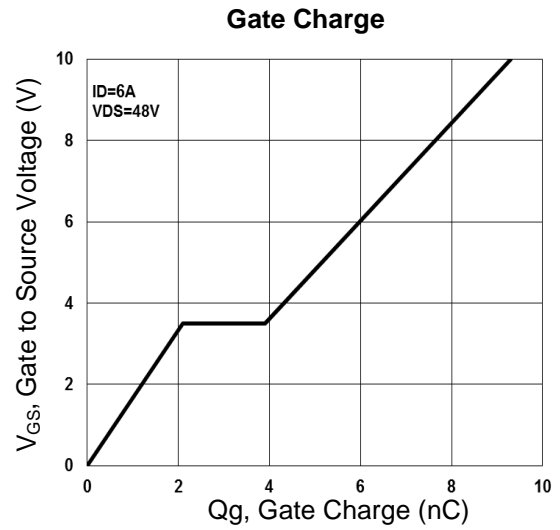
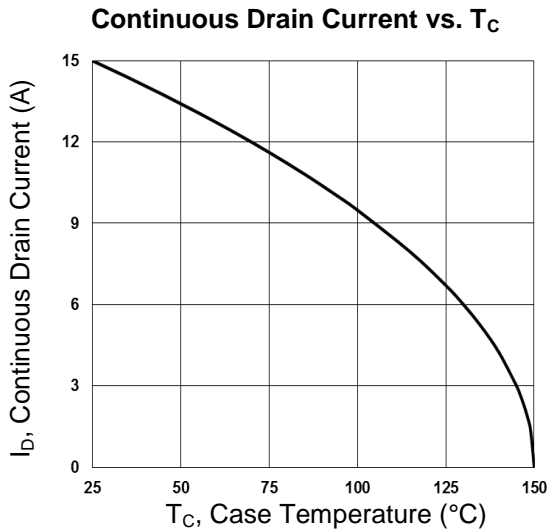
PART NO.	PACKAGE	PACKING
TSM900N10CH X0G	TO-251S (IPAK SL)	75pcs / Tube
TSM900N10CP ROG	TO-252 (DPAK)	2,500pcs / 13" Reel

Note:

1. Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
2. Halogen-free according to IEC 61249-2-21 definition

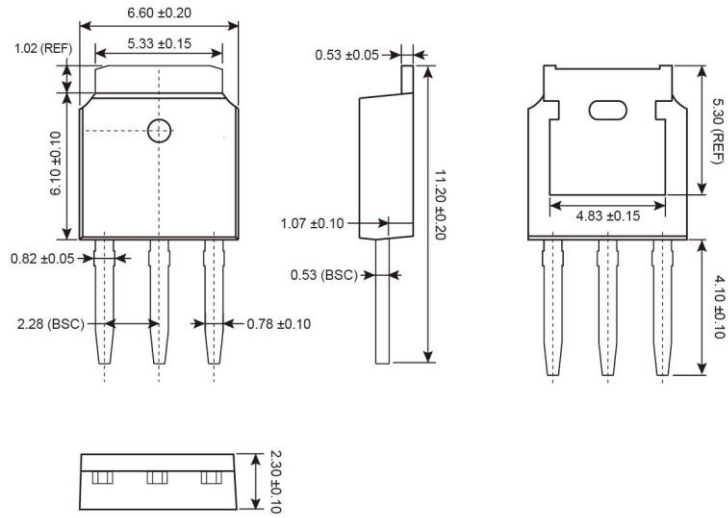
CHARACTERISTICS CURVES

($T_C = 25^\circ\text{C}$ unless otherwise noted)

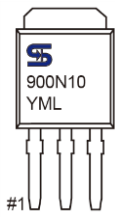


PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

TO-251S (IPAK SL)



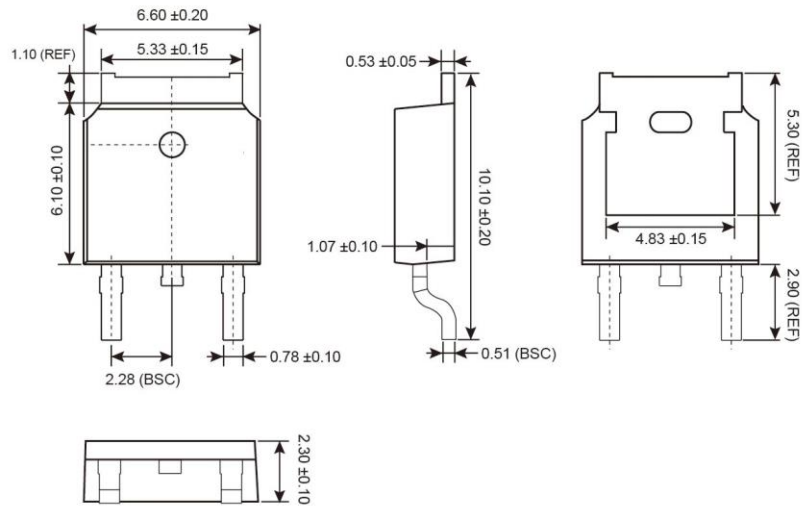
MARKING DIAGRAM



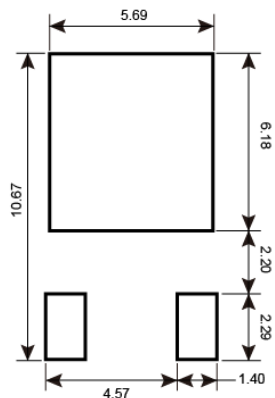
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- M** = Month Code for Halogen Free Product
 - O** =Jan **P** =Feb **Q** =Mar **R** =Apr
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- L** = Lot Code (1~9, A~Z)

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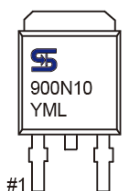
TO-252 (DPAK)



SUGGESTED PAD LAYOUT



MARKING DIAGRAM



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